

Pin Description

Name	Pin #	Type	Description
GND	1, 9, 13	P	Connect to Ground
CLK_EN	2	I_PU	Synchronized clock enable. When high, clock outputs follow clock input. When low, Q_x outputs are forced low, ${}_nQ_x$ outputs are forced high. LVCMOS/LVTTL level with $80k\Omega$ pull up.
CLK_ SEL	3	I_PD	Clock select input. When high, selects CLK_1 input. When low, selects CLK_0 input. LVCMOS/LVTTL level with $80k\Omega$ pull down.
CLK	4	I_PD	Non-inverting differential clock input
nCLK	5	I_PU	Inverting differential clock input
PCLK	6	I_PD	Non-inverting differential clock input
nPCLK	7	I_PU	Inverting differential clock input
OE	8	I_PU	Output Enable, Controls outputs Q ₀ , _n Q ₀ through Q ₃ , _n Q ₃
V_{CC}	10, 18	P	Connect to 3.3V.
Q ₃ , _n Q ₃	11, 12	О	Differential output pair, LVDS interface level.
Q ₂ , _n Q ₂	14, 15	О	Differential output pair, LVDS interface level.
$Q_1, {}_nQ_1$	16, 17	О	Differential output pair, LVDS interface level.
Q_0, nQ	19, 20	О	Differential output pair, LVDS interface level.

Notes:

Pin Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
C_{IN}	Input Capacitance			6		pF
R_pullup	Input Pullup Resistance			80		1-0
R_pulldown	Input Pulldown Resistance			80		kΩ

Control Input Function Table

		Inputs		Outputs		
OE	CLK_EN	CLK_SEL	Selected Source	Q ₀ :Q ₃	nQ0:nQ3	
1	0	0	CLK, nCLK	Diasbled: Low	Diasbled: High	
1	0	1	PCLK, nPCLK	Disabled: Low	Disabled: High	
1	1	0	CLK, nCLK	Enabled	Enabled	
1	1	1	PCLK, nPCLK	Enabled	Enabled	
0	X	Х		Hi-Z	Hi-Z	

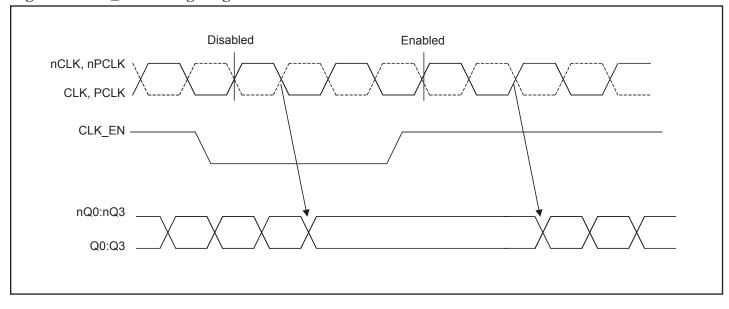
Notes:

1. After CLK_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock edge as show below.

^{1.} I = Input, O = Output, P = Power supply connection, I PD = Input with pull down, I PU = Input with pull up



Figure 1. CLK_EN Timing Diagram



Clock Input Function Table (See Figure 2)

Iı	nputs	Out	tputs	Innut to Output Mode	Dolowitz
CLK or PCLK	_n CLK or _n PCLK	Q ₀ :Q ₃	nQ0:nQ3	Input to Output Mode	Polarity
0	1	LOW	HIGH	Differential to Differential	None Inverting
1	0	HIGH	LOW	Differential to Differential	None Inverting
0	Biased; $V_{IN} = V_{CC}/2$	LOW	HIGH	Single Ended to Differential	None Inverting
1	Biased; $V_{IN} = V_{CC}/2$	HIGH	LOW	Single Ended to Differential	None Inverting
Biased; V _{IN} = Vcc/2	0	HIGH	LOW	Single Ended to Differential	Inverting
Biased; V _{IN} = V _{CC} /2	1	LOW	HIGH	Single Ended to Differential	Inverting

Absolute Maximum Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{CC}	Supply voltage	Referenced to GND			4.6	
V_{IN}	Input voltage	Referenced to GND	-0.5		V _{CC} +0.5V	V
V _{OUT}	Output voltage	Referenced to GND	-0.5		V _{CC} +0.5V	
T _{STG}	Storage temperature		-65		150	°C

Notes

1. Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. These ratings are stress speci fications only and correct functional operation of the device at these or any other conditions above those listed in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.



Operating Conditions

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{CC}	Power Supply Voltage		3.135	3.3	3.465	V
$T_{\mathbf{A}}$	Ambient Temperature		-40		85	°C
I _{CC}	Power Supply Current				60	mA

LVCMOS/LVTTL DC Characteristics ($T_A = -40^{\circ}\text{C}$ to 85°C , $V_{CC} = 3.135\text{V}$ to 3.465V unless otherwise stated below.)

Symbol	Pa	arameter	Conditions	Min.	Тур.	Max.	Units
V_{IH}	Input High Volt	tage		2		3.765	V
V_{IL}	Input Low Volt	age		-0.3		0.8	V
	Input High	CLK_SEL	$V_{IN} = V_{CC} = 3.465V$			150	
I_{IH}	Current	CLK_EN, OE	$V_{IN} = V_{CC} = 3.465V$			5	μA
T	Input Low	CLK_SEL	$V_{IN} = 0V, V_{CC} = 3.465V$	-5			μΑ
$I_{ m IL}$	Current	CLK_EN, OE	$V_{IN} = 0V, V_{CC} = 3.465V$	-150			

Differential DC Characteristics ($T_A = -40^{\circ}$ C to 85°C, $V_{CC} = 3.135$ V to 3.465V unless otherwise stated below.)

Symbol	Parar	neter	Conditions	Min.	Тур.	Max.	Units
т	Input High	nCLK, nPCLK	$V_{IN} = V_{CC} = 3.465V$			5	uA
I _{IH}	Current	CLK, PCLK	$V_{IN} = V_{CC} = 3.465V$			150	uA
T	Input Low	nCLK, nPCLK	$V_{CC} = 3.465V, V_{IN} = 0V$	-150			uA
$I_{ m IL}$	Current	CLK, PCLK	$V_{CC} = 3.465 V, V_{IN} = 0 V$	-5			uA
V _{PP}	Peak-to-peak Voltag	ge		0.15		1.3	V
V _{CMR}	Common Mode Inp	out Voltage ⁽¹⁾		0.5		V _{CC} - 0.85V	V

Notes:

LVPECL DC Characteristics ($T_A = -40^{\circ}$ C to 85° C, $V_{CC} = 3.135$ V to 3.465V unless otherwise stated below.)

Symbol	Pa	arameter	Conditions	Min.	Тур.	Max.	Units
т	Input High	nCLK, nPCLK	$V_{IN} = V_{CC} = 3.465V$			5	
$ m I_{IH}$	Current	CLK, PCLK	$V_{IN} = V_{CC} = 3.465V$			150	μA
ī	Input Low	nCLK, nPCLK	$V_{CC} = 3.465 \text{V}, V_{IN} = 0 \text{V}$	-150			μΑ
${ m I}_{ m IL}$	Current	CLK, PCLK	$V_{CC} = 3.465 \text{V}, V_{IN} = 0 \text{V}$	-5			
V_{PP}	Peak-to-peak Volt	age		0.3		1	V
V _{CMR}	Common Mode In	nput Voltage; Note ⁽¹⁾		1.5		V_{CC}	\ \ \

Notes:

^{1.} For single ended applications, the maximum input voltage for CLK and nCLK is V_{CC} +0.3V

^{1.} For single ended applications, the maximum input voltage for PCLK and nPCLK is V_{CC}+0.3V.



LVDS DC Characteristics ($T_A = -40^{\circ}$ C to 85°C, $V_{CC} = 3.135$ V to 3.465V unless otherwise stated below.)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
V _{OD}	Differential Output Voltage		200	280	360	mV
ΔV_{OD}	VOD Magnitude Change			0	40	
Vos	Offset Voltage		1.125	1.25	1.375	V
ΔV_{OS}	VOS Magnitude Change			5	25	mV
I _{OZ}	High Impedance Leakage Current		-10		+10]
I _{OFF}	Power OFF Leakage		-20	±1	+20	μΑ
I _{OSD}	Differential Output Short Circuit Current			-3.5	-5] ,,, 1
Ios	Output Short Circuit Current			-3.5	-5	mA
V _{OH}	Output Voltage High			1.34	1.6	V
V _{OL}	Output Voltage Low		0.9	1.06]

AC Characteristics ($T_A = -40^{\circ}\text{C}$ to 85°C , $V_{CC} = 3.135\text{V}$ to 3.465V)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
f _{max}	Output Frequency				800	MHz
t _{Pd}	Propagation Delay ⁽¹⁾	f ≤ 800 MHz	1.0		2.2	ns
Tsk(o)	Output-to-output Skew ⁽²⁾				40	
Tsk(pp)	Part-to-part Skew ⁽³⁾				300	ps
t _r /t _f	Output Rise/Fall time	20% - 80%	100		300	
odc	Output duty cycle		48		52	%

Notes:

- 1. Measured from the differential input crossing point to the differential output crossing point
- 2 Skew between outputs with the same supply voltage and equal load conditions. Measured at the differential outputs crossing point.
- Skew between outputs on different parts operating with the same supply voltage and equal load conditions. Measured at the differential outputs crossing point.
- 4. All parameters are measured at 500 MHz unless noted otherwise

Applications Information

Wiring the differential input to accept single ended levels

Figure 1 shows how the differential input can be wired to accept single ended levels. The reference voltage $V_REF = V_{DD}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to postion the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{DD} = 3.3V$, V_REF should be 1.25V and R1/R2 = 0.609.

08-0247 5 PS8771B 10/02/08



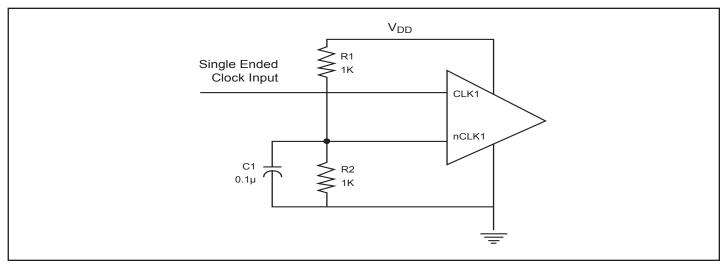
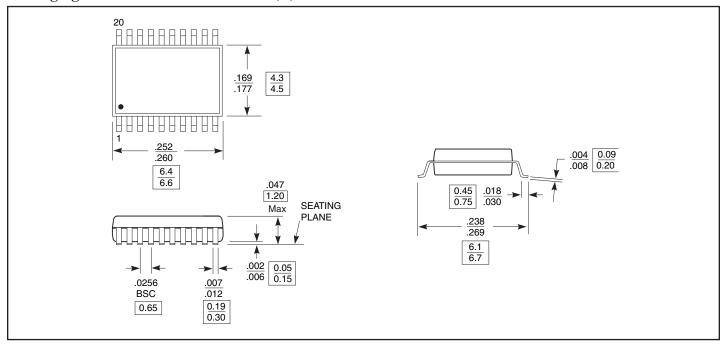


Figure 1: Single-ended Signal Driving Differential Input

Packaging Mechanical: 20-Pin TSSOP (L)



Ordering Information

Ordering Code	Package Code	Package Description
PI6C48543LE	L	Pb-free & Green 20-pin 173-mil wide TSSOP

Notes:

1. Thermal characteristics can be found on the company web site at www.pericom.com/packaging/